

PATENT TO

8013-1089-3

IN THE U.S. PATENT AND TRADEMARK OFFICE

In re application of

Kazuhiko ENDO

Conf. 6839

Application No. 10/017,396

Group 2813

Filed December 18, 2001

Examiner Y. Huynh

SILICA INSULATION FILM WITH A REDUCED DIELECTRIC CONSTANT AND METHOD OF FORMING THE SAME

AMENDMENT

Assistant Commissioner for Patents P.O. Box 1450

October 15, 2004

Alexandria, VA 22313-1450

Sir:

In response to the Official Action mailed June 15, 2004, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins below of this paper.

Remarks begin on page 9 of this paper.

An $\mbox{\bf Appendix}$ is attached following the signature page of this paper.

10/19/2004 HVUONG1 00000055 250120 10017396 01 FC:1201 88.00 DA